DISCRETE SEMICONDUCTORS

DATA SHEET



BZD142W ZenBlockTM; zener with integrated blocking diode

Product specification Supersedes data of 2000 May 01 2001 Oct 10



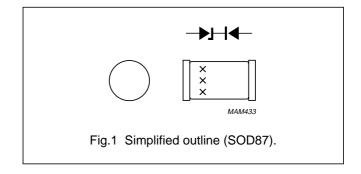


ZenBlockTM; zener with integrated blocking diode

BZD142W

FEATURES

- Zener and 600 V/100 ns blocking function in one package⁽¹⁾
- Protects MOSFETS or power IC controllers such as TINYSwitch^{TM(2)}, TOPSwitch^{TM(2)} and STARplug^{TM(3)}
- · Glass passivated
- · Excellent clamping capability and stability
- Supplied in 8 mm embossed tape.



DESCRIPTION

Cavity free cylindrical glass package through Implotec^{™(4)} technology. This package is hermetically sealed and fatigue free as coefficients of expansion of all used parts are matched.

(4) Implotec is a trademark of Koninklijke Philips Electronics N.V.

(1) Types BZD142W-68,-100 and -160 have a 600 V blocking diode with a minimum t_{rr} of 1000 ns.

- (2) TINYSwitch and TOPSwitch are trademarks of Power Integrations.
- (3) STARplug is a trademark of Koninklijke Philips Electronics N.V.

LIMITING VALUES

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT		
T _{stg}	storage temperature		-65	+150	°C		
Tj	junction temperature		-65	+150	°C		
Limiting v	alues zener						
P _{tot}	total power dissipation	T _{tp} = 105 °C; see Fig.2	_	1.5	W		
P _{RSM}	non-repetitive peak reverse power dissipation	10/1000 μs exponential pulse; $T_j = 25$ °C prior to surge; see Fig.5	_	100	W		
Limiting v	Limiting values blocking diode						
V _R	continuous reverse voltage		_	600	V		
E _{RSM}	non-repetitive peak reverse avalanche energy	L = 120 mH; $T_j = T_{j \text{ max}}$ prior to surge; inductive load switched off	_	7.5	mJ		

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ELECTRICAL CHARACTERISTICS ZENER/TVS

 $T_i = 25$ °C unless otherwise specified.

TYPE	WORKING VOLTAGE		TEMPERATURE COEFFICIENT		TEST CURRENT	CLAMPING VOLTAGE		REVERSE CURRENT at STAND-OFF VOLTAGE			
NUMBER SUFFIX ⁽¹⁾	V	_Z (V) at I _{te}	est	S _Z (%/K	() at I _{test}	I _{test} (mA)	V _{(CL)R} (V)	at I _{RSM} (A) ⁽²⁾	I _R (μ A)	at V _R (V)	
	MIN.	NOM.	MAX.	MIN.	MAX.		MAX.	(A)(-/	MAX.		
68	61	68	75	0.07	0.12	10	106	0.94	5	56	
100	90	100	110	0.07	0.12	5	139	0.72	5	82	
160	149	160	171	0.07	0.12	5	224	0.45	5	130	
180	162	180	198	0.07	0.12	5	250	0.40	5	150	
200	180	200	220	0.07	0.12	5	277	0.36	5	160	

Notes

- 1. To complete the type number the suffix is added to the basic type number, e.g. BZD142W-68.
- 2. Non-repetitive peak reverse current in accordance with "IEC 60060-1, Section 8" (10/1000 μs pulse); see Fig.5.

ELECTRICAL CHARACTERISTICS BLOCKING DIODE

 $T_i = 25$ °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{(BR)R}	reverse avalanche breakdown voltage	I _R = 0.1 mA	700	_	_	V
I _R	reverse current	V _R = 600 V	_	_	5	μΑ
		V _R = 600 V; T _j = 150 °C	_	_	100	μΑ
C _d	diode capacitance	$f = 1 \text{ MHz}$; $V_R = 0 \text{ V}$; see Fig.3	_	15	_	pF

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-tp}	thermal resistance from junction to tie-point		30	K/W
R _{th j-a}	thermal resistance from junction to ambient	note 1	150	K/W

Note

1. Device mounted on an epoxy-glass printed-circuit board, 1.5 mm thick; thickness of Cu-layer ≥40 μm, see Fig.4. For more information please refer to the "General Part of associated Handbook".

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GRAPHICAL DATA

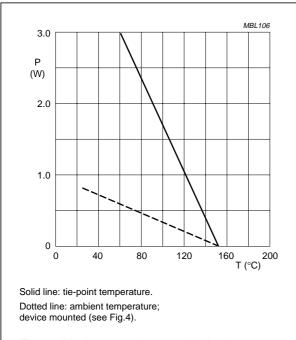
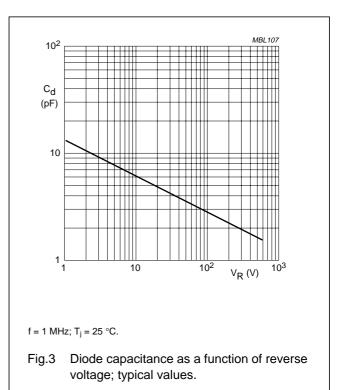
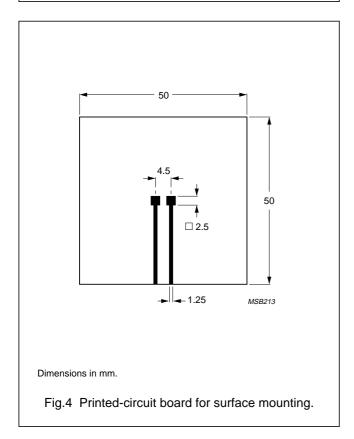
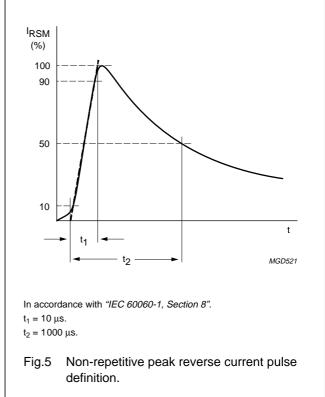


Fig.2 Maximum total power dissipation as a function of temperature.







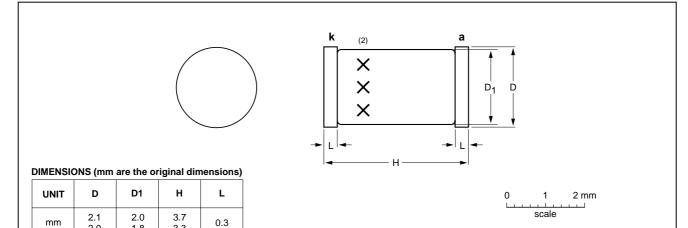
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PACKAGE OUTLINE

Hermetically sealed glass surface mounted package; Implotec^{TM(1)} technology; 2 connectors

SOD87



Notes

- 1. Implotec is a trademark of Philips.
- 2. The marking indicates the cathode.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOD87	100H03					-99-03-31 99-06-04	

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DATA SHEET STATUS

DATA SHEET STATUS(1)	PRODUCT STATUS ⁽²⁾	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A.

Notes

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- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

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NOTES

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